

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
38180000	Chemical elements doped for use in electronics, in form of discs, wafers or similar forms; chemical compounds doped for use in electronics.	0	0	0	G/94			0		1		
7017	Laboratory, hygienic or pharmaceutical glassware, whether or not graduated or calibrated.											
70171000	-Of fused quartz or other fused silica											
x 70171000	--Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers	5.1%	0	2000	WT/Let			0			113	
70200000	Other articles of glass.											
x 70200000	-Quartz reactor tubes and holders designed for insertion into diffusion and oxidation furnaces for production of semiconductor wafers	5.6%	0	2000	WT/Let			0			113	
8421	Centrifuges, including centrifugal dryers, filtering or purifying machinery and apparatus, for liquids or gases; parts thereof.											
	-Centrifuges, including centrifugal dryers:											
84211900	--Other											
x 84211900	---Spin dryers for semiconductor wafer processing	2.3%	0	2000	WT/Let			0			116	
	-Parts:											
842191	--Of centrifuges, including centrifugal dryers											
84219160	---Other											
x 84219160	----Of spin dryers for semiconductor wafer processing	1.6%	0	1999	WT/Let			0			117	
8424	Mechanical appliances (whether or not hand-operated) for projecting, dispersing or spraying liquids or powders; fire extinguishers, whether or not charged; spray guns and similar appliances; steam or sand blasting machines and similar jet projecting machines; parts thereof.											
842430	-Steam or sand blasting machines and similar jet projecting machines											
84243090	--Other											

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84243090	---Deflash machines for cleaning and removing contaminants from the metal leads of semiconductor packages prior to the electroplating process (deflash by projectile beads) -Other appliances:	1.5%	0	1999	WT/Let			0		118		
842489	--Other											
84248930	---Spraying appliances designed for etching, stripping or cleaning semiconductor wafers	0	0	0	G/94			0		119,142, 168		
84248990	---Other											
84248990	----Spraying appliances for developing semiconductor wafers; spraying appliances for etching, developing, stripping or cleaning flat panel displays; deflash machines for cleaning and removing contaminants from the metal leads of semiconductor packages prior to the electroplating process (deflash by high pressure spray)	2.6%	0	2000	WT/Let			0		118,142, 168		
842490	-Parts											
84249090	--Other											
84249090	---Of spraying appliances for etching, developing, stripping or cleaning semiconductor wafer and flat panel displays	1.5%	0	1999	WT/Let			0		120,135, 153,169		
8428	Other lifting, handling , loading or unloading machinery (for example, elevators, escalators, conveyors, teleferics).											
84282000	-Pnuematic elevators and conveyors											
84282000	--For automated transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices -Other continuous-action elevators and conveyors, for goods or materials:	0.8%	0	1999	WT/Let			0		139		
84283300	--Other, belt type											
84283300	---For automated transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	0.8%	0	1999	WT/Let			0		139		
84283900	--Other											

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84283900	---For automated transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	0.8%	0	1999	WT/Let			0		139		
84289000	-Other machinery											
84289000	--For automated transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	0.8%	0	1999	WT/Let			0		139		
8431	Parts suitable for use solely or principally with the machinery of headings 8425 to 8430.											
	-Of machinery of heading 8428											
84313900	--Other											
84313900	---Of automated machines of subheading 8428.20, 8428.33, 8428.39 or 8428.90 for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other material for semiconductor devices	0.8%	0	1999	WT/Let			0		154		
8456	Machine tools for working any material by removal of material, by laser or other light or photon beam, ultrasonic, electro-discharge, electro-chemical, electron beam, ionic-beam or plasma arc processes.											
845610	-Operated by laser or other light or photon beam processes											
84561050	--Other											
84561050	---For use in the production of semiconductor wafers; lasercutters for cutting contacting tracks in semiconductor production	2.6%	0	2000	WT/Let			0		121,125		
	-Other:											
84569100	--For dry-etching patterns on semiconductor materials	0	0	0	G/94			0		123		
845699	--Other											
	---For working metal:											
84569910	----Focused ion beam milling machines designed to produce or repair masks and reticles of semiconductor device designs	0	0	0	G/94			0		124		
84569950	---Other											
84569950	----For stripping or cleaning semiconductor wafers	2.5%	0	2000	WT/Let			0		122		

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8462	Machine tools (including presses) for working metal by forging, hammering or die-stamping; machine tools (including presses) for working metal by bending, folding, straightening, flattening, shearing, punching or notching; presses for working metal or metal carbides, not specified above. -Bending, folding, straightening or flattening machines (including presses):										
84622100	--Numerically controlled										
x 84622100	---For bending, folding and straightening semiconductor leads	4.4%	0	2000	WT/Let			0		146	
84622900	--Other										
x 84622900	---For bending, folding and straightening semiconductor leads	4.4%	0	2000	WT/Let			0		146	
8464	Machine tools for working stone, ceramics, concrete, asbestos-cement or like mineral materials or for cold working glass.										
84641000	-Sawing machines	0	0	0	G/94			0		126,128	
846420	-Grinding or polishing machines										
84642010	--Machines designed to process semiconductor wafers	0	0	0	G/94			0		127	
846490	-Other										
84649010	--Machines designed to scribe or score semiconductor wafers into finished chips or die; wet chemical etching machines designed to process semiconductor wafers	0	0	0	G/94			0		128,142,168	
84649050	--Other										
x 84649050	---Machines for wet-developing or -stripping semiconductor wafers; machines for wet-etching, -developing or -stripping flat panel displays	2.4%	0	2000	WT/Let			0		142,168	
8465	Machine tools (including machines for nailing, stapling, glueing or otherwise assembling) for working wood, cork, bone, hard rubber, hard plastics or similar hard materials. -Other:										
84659900	--Other										

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84659900	---Deflash machines for cleaning and removing contaminants from the metal leads of semiconductor packages prior to the electroplating process (deflash by chemical bath)	2.6%	0	2000	WT/Let			0			118	
8466	Parts and accessories suitable for use solely or principally with the machines of headings 8456 to 8465, including work or tool holders, self-opening dieheads, dividing heads and other special attachments for machine tools; tool holders for any type of tool for working in the hand.											
84661000	-Tool holders and self-opening dieheads											
84661000	--Tool holders for any of the following: machines of subheading 8456.10.50 for use in the production of semiconductor wafers; lasercutters of subheading 8456.10.50 for cutting contacting tracks in semiconductor production; machines of subheading 8456.91; machines of subheading 8456.99.10; machines of subheading 8456.99.50 for stripping or cleaning semiconductor wafers; machines of subheading 8462.21 or 8462.29 for bending, folding and straightening semiconductor leads; machines of subheading 8464.10 for sawing monocrystal semiconductor boules into slices, or wafers into chips; machines of subheading 8464.20.10; machines of subheading 8464.90 for scribing or scoring semiconductor wafers; machines of subheading 8464.90 for wet-etching, -developing or -stripping semiconductor wafers and flat panel displays	4.3%	0	2000	WT/Let			0			129,130, 131,132, 133,134, 135,136, 153,157, 169	
846620	-Work holders											
84662090	--Other											

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⌘ 84662090	---For machines of subheading 8456.10.50 for use in the production of semiconductor wafers; for lasercutters of subheading 8456.10.50 for cutting contacting tracks in semiconductor production; for machines of subheading 8456.91; for machines of subheading 8456.99.10; for machines of subheading 8456.99.50 for stripping or cleaning semiconductor wafers; for machines of subheading 8462.21 or 8462.29 for bending, folding and straightening semiconductor leads; for machines of subheading 8464.10 for sawing monocrystal semiconductor boules into slices, or wafers into chips; for machines of subheading 8464.20.10; for machines of subheading 8464.90 for scribing or scoring semiconductor wafers; for machines of subheading 8464.90 for wet-etching, -developing or -stripping semiconductor wafers and flat panel displays	4.1%	0	2000	WT/Let			0		129,130, 131,132, 133,134, 135,136, 153,157, 169		
846630	-Dividing heads and other special attachments for machine tools --Other special attachments:											
84663030	---Machines											
⌘ 84663030	----For machines of subheading 8456.10.50 for use in the production of semiconductor wafers; for lasercutters of subheading 8456.10.50 for cutting contacting tracks in semiconductor production; for machines of subheading 8456.91; for machines of subheading 8456.99.10; for machines of subheading 8456.99.50 for stripping or cleaning semiconductor wafers; for machines of subheading 8462.21 or 8462.29 for bending, folding and straightening semiconductor leads; for machines of subheading 8464.10 for sawing monocrystal semiconductor boules into slices, or wafers into chips; for machines of subheading 8464.20.10; for machines of subheading 8464.90 for scribing or scoring semiconductor wafers; for machines of subheading 8464.90 for wet-etching, -developing or -stripping semiconductor wafers and flat panel displays	3.2%	0	2000	WT/Let			0		129,130, 131,132, 133,134, 135,136, 153,157, 169		
84663050	---Other											

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84663050	----For machines of subheading 8456.10.50 for use in the production of semiconductor wafers; for lasercutters of subheading 8456.10.50 for cutting contacting tracks in semiconductor production; for machines of subheading 8456.91; for machines of subheading 8456.99.10; for machines of subheading 8456.99.50 for stripping or cleaning semiconductor wafers; for machines of subheading 8462.21 or 8462.29 for bending, folding and straightening semiconductor leads; for machines of subheading 8464.10 for sawing monocrystal semiconductor boules into slices, or wafers into chips; for machines of subheading 8464.20.10; for machines of subheading 8464.90 for scribing or scoring semiconductor wafers; for machines of subheading 8464.90 for wet-etching, -developing or -stripping semiconductor wafers and flat panel displays -Other:	8.6%	0	2000	WT/Let			0		129,130, 131,132, 133,134, 135,136, 153,157, 169		
846691	--For machines of heading 8464											
84669110	---Cast-iron parts not advanced beyond cleaning, and machined only for the removal of fins, gates, sprues and risers or to permit location in finishing machinery	0	0	0	G/HS/88			0		129,130, 131,135, 153,169		
84669150	---Other											
84669150	----Of machines of subheading 8464.10 for sawing monocrystal semiconductor boules into slices, or wafers into chips; of machines of subheading 8464.20.10; of machines of subheading 8464.90 for scribing or scoring semiconductor wafers; of machines of subheading 8464.90 for wet-etching, -developing or -stripping semiconductor wafers and flat panel displays	1.9%	0	1999	WT/Let			0		129,130, 131,135, 153,169		
846693	--For machines of headings 8456 to 8461 ---Bed, base, table, head, tail, saddle, cradle, cross slide, column, arm, saw arm, wheelhead, tailstock, headstock, ram, frame, work-arbor support, and C-frame castings, weldments or fabrications:											

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84669315	----Cast-iron parts not advanced beyond cleaning, and machined only for the removal of fins, gates, sprues and risers or to permit location in finishing machinery ----Other:	0	0	0	G/HS/88			0			132,133, 134,135, 136	
84669345	----Other											
x 84669345	-----Of machines of subheading 8456.10.50 for use in the production of semiconductor wafers; of lasercutters of subheading 8456.10.50 for cutting contacting tracks in semiconductor production; of machines of subheading 8456.91; of machines of subheading 8456.99.10; of machines of subheading 8456.99.50 for stripping or cleaning semiconductor wafers ---Other:	4.7%	0	2000	WT/Let			0			132,133, 134,135, 136	
84669360	----Cast-iron parts not advanced beyond cleaning, and machined only for the removal of fins, gates, sprues and risers or to permit location in finishing machinery ----Other:	0	0	0	G/HS/88			0			132,133, 134,135, 136	
84669390	----Other											
x 84669390	-----Of machines of subheading 8456.10.50 for use in the production of semiconductor wafers; of lasercutters of subheading 8456.10.50 for cutting contacting tracks in semiconductor production; of machines of subheading 8456.91; of machines of subheading 8456.99.10; of machines of subheading 8456.99.50 for stripping or cleaning semiconductor wafers	4.7%	0	2000	WT/Let			0			132,133, 134,135, 136	
846694	--For machines of heading 8462 or 8463 ---Cast-iron parts not advanced beyond cleaning, and machined only for the removal of fins, gates, sprues and risers or to permit location in finishing machinery:											
84669420	----Bed, base, table, column, cradle, frame, bolster, crown, slide, rod, tailstock and headstock castings, weldments or fabrications	0	0	0	G/HS/88			0			157	
84669440	----Other ---Other:	0	0	0	G/HS/88			0			157	

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84669460	----Bed, base, table, column, cradle, frame, bolster, crown, slide, rod, tailstock and headstock castings, weldments or fabrications										
x 84669460	-----Of machines of subheading 8462.21 or 8462.29 for bending, folding and straightening semiconductor leads	4.7%	0	2000	WT/Let			0		157	
84669480	----Other										
x 84669480	-----Of machines of subheading 8462.21 or 8462.29 for bending, folding and straightening semiconductor leads	4.7%	0	2000	WT/Let			0		157	
8469	Typewriters other than printers of heading 8471; word processing machines. -Automatic typewriters and word-processing machines:										
84691100	--Word processing machines	0.9%	0	1999	WT/Let			0	2		
8470	Calculating machines and pocket-size data recording, reproducing and displaying machines with calculating functions; accounting machines, postage-franking machines, ticket-issuing machines and similar machines, incorporating a calculating device; cash registers.										
84701000	-Electronic calculators capable of operation without an external source of electric power and pocket-size data recording, reproducing and displaying machines with calculating functions -Other electronic calculating machines:	2.6%	0	1997	WT/Let			0	3		
84702100	--Incorporating a printing device	2.6%	0	2000	WT/Let			0	4		
84702900	--Other	2.6%	0	2000	WT/Let			0	5		
84703000	-Other calculating machines	2.6%	0	2000	WT/Let			0	6		
84704000	-Accounting machines	1.6%	0	1997	WT/Let			0	7		
84705000	-Cash registers	0	0	0	G/HS/88			0	8		
84709000	-Other	2.7%	0	1997	WT/Let			0	9		
8471	Automatic data processing machines and units thereof; magnetic or optical readers, machines for transcribing data onto data media in coded form and machines for processing such data, not elsewhere specified or included.										
84711000	-Analog or hybrid automatic data processing machines	3.4%	0	2000	WT/Let			0	10		191,

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84713000	-Portable digital automatic data processing machines, weighing not more than 10 kg, consisting of at least a central processing unit, a keyboard and a display -Other digital automatic data processing machines:	2.7%	0	2000	WT/Let			0		11		191,
84714100	--Comprising in the same housing at least a central processing unit and an input and output unit, whether or not combined	2.7%	0	2000	WT/Let			0		12		191,
847149	--Other, entered in the form of systems											
84714910	---Digital processing units entered with the rest of a system, whether or not containing in the same housing one or two of the following types of unit: storage units, input units, output units ---Input or output units, entered with the rest of a system, whether or not containing storage units in the same housing:	2.7%	0	1997	WT/Let			0		13		191,
84714915	----Combined input/output units ----Other:	1.5%	0	1997	WT/Let			0		13		193,195,
84714921	-----Keyboards -----Display units:	0	0	0	G/94			0		13		
84714924	-----Without cathode-ray tube (CRT), having a visual display diagonal not exceeding 30.5 cm -----Other:	0	0	0	G/94			0		13		193,200,
84714926	-----With color cathode-ray tube (CRT)	1.5%	0	1999	WT/Let			0		13		195,
84714929	-----Other -----Printer units: -----Laser:	1.5%	0	1999	WT/Let			0		13		193,195,
84714931	-----Capable of producing more than 20 pages per minute	1.5%	0	1997	WT/Let			0		13		198,
84714932	-----Other	1.5%	0	1999	WT/Let			0		13		198,
84714933	-----Light bar electronic type	1.5%	0	1997	WT/Let			0		13		198,
84714934	-----Ink jet	1.5%	0	1999	WT/Let			0		13		198,
84714935	-----Thermal transfer	1.5%	0	1997	WT/Let			0		13		198,
84714936	-----Ionographic	1.5%	0	1997	WT/Let			0		13		198,
84714937	-----Other -----Other:	1.5%	0	1997	WT/Let			0		13		198,

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84714942	-----Optical scanners and magnetic ink recognition devices	1.5%	0	1999	WT/Let		0	13			
84714948	-----Other	1.5%	0	1997	WT/Let		0	13			
84714950	---Storage units, entered with the rest of a system ---Other:	1.5%	0	1997	WT/Let		0	13			196,201,
84714960	----Control or adapter units	0	0	0	G/94		0	13			194,
84714970	----Power supplies ----Other:	1.2%	0	1997	WT/Let		0	13			
84714985	-----Units suitable for physical incorporation into automatic data processing machines or units thereof	0	0	0	G/94		0	13			
84714995	-----Other	1.5%	0	1997	WT/Let		0	13			
847150	-Digital processing units other than those of subheadings 8471.41 and 8471.49, whether or not containing in the same housing one or two of the following types of unit: storage units, input units, output units										
84715040	--Digital processing units for automatic data processing machines, unhoused, consisting of a printed circuit (single or multiple) with one or more electronic integrated circuits or other semiconductor devices mounted directly thereon, certified as units designed for use other than in automatic data processing machines of subheading 8471.30 or 8471.41	0	0	0	G/94		0	14			191,199,
84715080	--Other	2.7%	0	1997	WT/Let		0	14			191,199,
847160	-Input or output units, whether or not containing storage units in the same housing										
84716010	--Combined input/output units --Other:	1.5%	0	1997	WT/Let		0	15			193,195,
84716020	---Keyboards ---Display units:	0	0	0	G/94		0	15			
84716030	----Without cathode-ray tube (CRT), having a visual display diagonal not exceeding 30.5 cm ----Other:	0	0	0	G/94		0	15			193,200,
84716035	-----With color cathode-ray tube (CRT)	1.5%	0	1999	WT/Let		0	15			195,
84716045	-----Other	1.5%	0	1999	WT/Let		0	15			193,195,

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	---Printer units:										
	----Assembled units incorporating at least the media transport, control and print mechanisms:										
	-----Laser:										
84716051	-----Capable of producing more than 20 pages per minute	1.5%	0	1997	WT/Let		0	15			198,
84716052	-----Other	1.5%	0	1999	WT/Let		0	15			198,
84716053	-----Light bar electronic type	1.5%	0	1997	WT/Let		0	15			198,
84716054	-----Ink jet	1.5%	0	1999	WT/Let		0	15			198,
84716055	-----Thermal transfer	1.5%	0	1997	WT/Let		0	15			198,
84716056	-----Ionographic	1.5%	0	1997	WT/Let		0	15			198,
84716057	-----Other	1.5%	0	1997	WT/Let		0	15			198,
	----Other:										
	-----Laser:										
84716061	-----Capable of producing more than 20 pages per minute	0	0	0	G/94		0	15			198,
84716062	-----Other	0	0	0	G/94		0	15			198,
84716063	-----Light bar electronic type	0	0	0	G/94		0	15			198,
84716064	-----Ink jet	0	0	0	G/94		0	15			198,
84716065	-----Thermal transfer	0	0	0	G/94		0	15			198,
84716066	-----Ionographic	0	0	0	G/94		0	15			198,
84716067	-----Other	0	0	0	G/94		0	15			198,
	---Other:										
84716070	----Units suitable for physical incorporation into automatic data processing machines or units thereof	0	0	0	G/94		0	15			
	----Other:										
84716080	-----Optical scanners and magnetic ink recognition devices	1.5%	0	1999	WT/Let		0	15			
84716090	-----Other	1.5%	0	1997	WT/Let		0	15			
847170	-Storage units										
	--Magnetic disk drive units:										
	---For a disk of a diameter exceeding 21 cm:										
84717010	----Without read-write unit assembled therein; read-write units entered separately	0	0	0	G/94		0	16			201,

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
84717020	----Units for physical incorporation into automatic data processing machines or units thereof	0	0	0	G/94			0	16			201,
84717030	----Other	1.5%	0	1997	WT/Let			0	16			201,
	---Other:											
84717040	----Not assembled in cabinets, and without attached external power supply	0	0	0	G/94			0	16			201,
84717050	----Other	1.5%	0	1997	WT/Let			0	16			201,
	--Other storage units:											
84717060	---Not assembled in cabinets for placing on a table, desk, wall, floor or similar place	0	0	0	G/94			0	16			196,201,
84717090	---Other	1.5%	0	1997	WT/Let			0	16			196,201,
847180	-Other units of automatic data processing machines											
84718010	--Control or adapter units	0	0	0	G/94			0	17			194,
	--Other:											
84718040	---Units suitable for physical incorporation into automatic data processing machines	0	0	0	G/94			0	17			
84718090	---Other	1.5%	0	1997	WT/Let			0	17			
84719000	-Other	1.5%	0	1997	WT/Let			0	18			
8472	Other office machines (for example, hectograph or stencil duplicating machines, addressing machines, automatic banknote dispensers, coin-sorting machines, coin-counting or wrapping machines, pencil-sharpening machines, perforating or stapling machines).											
847290	-Other											
84729020	--Automatic banknote dispensers and other coin or currency handling machines											
x 84729020	---Automatic teller machines	2.6%	0	1997	WT/Let			0	19			
8473	Parts and accessories (other than covers, carrying cases and the like) suitable for use solely or principally with machines of headings 8469 to 8472.											
847310	-Parts and accessories of the machines of heading 8469											
	--Parts:											
84731030	---Of word processing machines											
x 84731030	----Printed circuit assemblies	2.8%	0	2000	WT/Let			0				199,

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
	-Parts and accessories of the machines of heading 8470:											
84732100	--Of the electronic calculating machines of subheading 8470.10, 8470.21 or 8470.29	2.7%	0	1997	WT/Let			0	20			199,
84732900	--Other	2.7%	0	1997	WT/Let			0	21			199,
847330	-Parts and accessories of the machines of heading 8471											
	--Not incorporating a cathode ray tube:											
84733010	---Printed circuit assemblies	0	0	0	G/94			0	22			193,199,202,
84733020	---Parts and accessories, including face plates and lock latches, of printed circuit assemblies	0	0	0	G/94			0	22			193,
84733030	---Other parts for printer, specified in additional U.S. additional note 2 to this chapter	0	0	0	G/94			0	22			
84733050	---Other	0	0	0	G/94			0	22			193,
	--Other:											
84733060	---Other parts for printer, specified in additional U.S. additional note 2 to this chapter	0	0	0	G/94			0	22			
84733090	---Other	0	0	0	G/94			0	22			
847340	-Parts and accessories of the machines of heading 8472											
84734020	--Of automatic banknote dispensers and other coin or currency handling machines of subheading 8472.90.20											
84734020	---Printed circuit assemblies for automatic teller machines	2.7%	0	2000	WT/Let			0				199,
847350	-Parts and accessories equally suitable for use with machines of two or more of the headings 8469 to 8472											
84735030	--Printed circuit assemblies	0	0	0	G/94			0	23			199,
84735060	--Parts and accessories, including face plates and lock latches, of printed circuit assemblies	0	0	0	G/94			0	23			
84735090	--Other	0	0	0	G/94			0	23			
8477	Machinery for working rubber or plastics or for the manufacture of products from these materials, not specified or included elsewhere in this chapter; parts thereof.											
847710	-Injection-molding machines											
84771080	--Other											

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
84771080	---For encapsulation in the assembly of semiconductors	3.4%	0	2000	WT/Let			0		137,144	
84774000	-Vacuum-molding machines and other thermoforming machines										
84774000	--Transfer molding and compression molding machines for encapsulation in the assembly of semiconductors	3.4%	0	2000	WT/Let			0		137,144	
84775900	-Other machinery for molding or otherwise forming: --Other										
84775900	---Liquid encapsulate molding machines for encapsulation in the assembly of semiconductors	3.4%	0	2000	WT/Let			0		137,144	
847790	-Parts										
84779020	--Base, bed, platen, clamp cylinder, ram, and injection castings, weldments and fabrications										
84779020	---Of machines of subheading 8477.10.80, 8477.40 or 8477.59 for encapsulation in the assembly of semiconductors	3.4%	0	2000	WT/Let			0		138,155	
84779040	--Barrel screws										
84779040	---Of machines of subheading 8477.10.80, 8477.40 or 8477.59 for encapsulation in the assembly of semiconductors	3.4%	0	2000	WT/Let			0		138,155	
84779060	--Hydraulic assemblies incorporating more than one of the following: manifold; valves; pump; oil cooler										
84779060	---Of machines of subheading 8477.10.80, 8477.40 or 8477.59 for encapsulation in the assembly of semiconductors	3.4%	0	2000	WT/Let			0		138,155	
84779080	--Other										
84779080	---Of machines of subheading 8477.10.80, 8477.40 or 8477.59 for encapsulation in the assembly of semiconductors	3.4%	0	2000	WT/Let			0		138,155	
8479	Machines and mechanical appliances having individual functions, not specified or included elsewhere in this chapter. -Other machines and mechanical appliances:										
847989	--Other ---Other:										

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
84798985	----Machines for processing of semiconductor materials; machines for production and assembly of diodes, transistors and similar semiconductor devices and electronic integrated circuits; machines for the manufacture of video laser discs	0	0	0	G/94			0			114,118, 140,141, 142,143, 145,147, 148,168	
84798995	----Other											
x 84798995	-----Machines for wet-cleaning flat panel displays	3%	0	2000	WT/Let			0			142,168	
847990	-Parts											
84799095	--Other											
x 84799095	--Of chemical vapor deposition machines for semiconductor production; of machines for cleaning semiconductor wafers; of physical deposition machines for semiconductor production; of die attach machines, of tape automated bonders and of wire bonders for assembly of semiconductors; of spinners for coating photographic emulsions on semiconductor wafers; of machines for growing or pulling monocrystal semiconductor boules; of machines for wet-cleaning flat panel displays; of epitaxial deposition machines for semiconductor wafers	1.5%	0	1999	WT/Let			0			115,135, 149,150, 151,152, 153,156, 158,169	
8480	Molding boxes for metal foundry; mold bases; molding patterns; molds for metal (other than ingot molds), metal carbides, glass, mineral materials, rubber or plastics. -Molds for rubber or plastics:											
848071	--Injection or compression types											
84807190	---Other											
x 84807190	----For the manufacture of semiconductor devices	3.4%	0	2000	WT/Let			0			159	
8504	Electrical transformers, static converters (for example, rectifiers) and inductors; parts thereof.											
850440	-Static converters --Power supplies for automatic data processing machines or units thereof of heading 8471:											
85044060	---Suitable for physical incorporation into automatic data processing machines or units thereof of heading 8471	0	0	0	G/94			0		24		199,

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
85044070	---Other	1.2%	0	1997	WT/Let			0	24			
85044090	--Other											
x 85044090	---For telecommunication apparatus	2.1%	0	1997	WT/Let			0	24			199,
85045000	-Other inductors											
x 85045000	--For power supplies for automatic data processing machines and units thereof, and telecommunication apparatus	3%	0	2000	WT/Let			0	25			
850490	-Parts											
	--Of power supplies for automatic data processing machines or units thereof of heading 8471:											
85049020	---Printed circuit assemblies	0	0	0	G/94			0				199,
	--Other:											
85049070	---Printed circuit assemblies											
x 85049070	---Of static convertors of subheading 8504.40 for automatic data processing machines and units thereof, and telecommunication apparatus; of other inductors of subheading 8504.50 for power supplies for automatic data processing machines and units thereof, and telecommunication apparatus	2.8%	0	2000	WT/Let			0				199,
8514	Industrial or laboratory electric (including induction or dielectric) furnaces and ovens; other industrial or laboratory induction or dielectric heating equipment; parts thereof.											
85141000	-Resistance heated furnaces and ovens											
x 85141000	--For the manufacture of semiconductor devices on semiconductor wafers	1%	0	1999	WT/Let			0			160	
85142000	-Induction or dielectric furnaces and ovens											
x 85142000	--For the manufacture of semiconductor devices on semiconductors wafers	1%	0	1999	WT/Let			0			161	
851430	-Other furnaces and ovens											
85143040	--Other											
x 85143040	---For rapid heating of semiconductor wafers	1.8%	0	2000	WT/Let			0			162	
85149000	-Parts											

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
xx 85149000	--Of furnaces and ovens of subheading 8514.10 or 8514.20 for the manufacture of semiconductor devices on semiconductor wafers; of furnaces and ovens of subheading 8514.30 for rapid heating of semiconductor wafers other than for diffusion, oxidation or annealing	1%	0	1999	WT/Let		0			163,164, 165	
8515	Electric (including electrically heated gas), laser or other light or photon beam, ultrasonic, electron beam, magnetic pulse or plasma arc soldering, brazing or welding machines and apparatus, whether or not capable of cutting; electric machines and apparatus for hot spraying of metals or cermets; parts thereof.										
85158000	-Other machines and apparatus										
xx 85158000	--Die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors	0.8%	0	1999	WT/Let		0			143	
851590	-Parts										
85159020	--Of welding machines and apparatus										
xx 85159020	---Of die attach apparatus, tape automated bonders, and wire bonders for assembly of semiconductors of subheading 8515.80	1.8%	0	2000	WT/Let		0			150	
8517	Electrical apparatus for line telephony or line telegraphy, including line telephone sets with cordless handsets and telecommunication apparatus for carrier-current line systems or for digital line systems; videophones; parts thereof. -Telephone sets; videophones:										
85171100	--Line telephone sets with cordless handsets	2.4%	0	1999	WT/Let		0		26		
851719	--Other										
85171940	---Videophones	8.5%	0	2000	WT/Let		0		27		
85171980	---Other	8.5%	0	2000	WT/Let		0		27		
	-Facsimile machines and teleprinters:										
85172100	--Facsimile machines	4.7%	0	2000	WT/Let		0		28		
85172200	--Teleprinters	4.7%	0	2000	WT/Let		0		29		
851730	-Telephonic or telegraphic switching apparatus --Telephonic switching apparatus (including private branch exchange and key system switching apparatus):										

HS96	Description	Base rate	Bound rate	Implementation	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	Earlier INRs	ODC	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
85173015	---Central office switching apparatus	8.5%	0	2000	WT/Let			0	30		
85173020	---Private branch exchange switching apparatus	8.5%	0	2000	WT/Let			0	30		
85173025	---Electronic key telephone systems	8.5%	0	2000	WT/Let			0	30		
85173030	---Other	8.5%	0	2000	WT/Let			0	30		
85173050	--Other	3.3%	0	2000	WT/Let			0	30		
851750	-Other apparatus, for carrier-current line systems or for digital line systems										
85175010	--Modems, of a kind used with data processing machines of heading 8471	3.3%	0	2000	WT/Let			0	31		199,202,203,
	--Other:										
85175050	---Telephonic	8.5%	0	2000	WT/Let			0	31		
	---Telegraphic:										
85175060	----For carrier-current line systems	3.3%	0	2000	WT/Let			0	31		
85175090	----Other	4.7%	0	2000	WT/Let			0	31		
851780	-Other apparatus										
85178010	--Telephonic	8.5%	0	2000	WT/Let			0	32		
85178020	--Telegraphic	4.7%	0	2000	WT/Let			0	32		
851790	-Parts										
	--Parts of facsimile machines:										
85179004	---Parts of facsimile machines specified in additional U.S. note 7 to this chapter	4.7%	0	2000	WT/Let			0	33		
85179008	---Other	4.7%	0	2000	WT/Let			0	33		199,
	--Other parts, incorporating printed circuit assemblies:										
85179012	---Parts for telephone sets	8.5%	0	2000	WT/Let			0	33		
	---Parts for articles of subheadings 8517.22, 8517.30, 8517.50.50 and 8517.80.10:										
85179016	----For teleprinters, including teletypewriters	4.7%	0	2000	WT/Let			0	33		
85179024	----For telephonic switching or terminal apparatus	8.5%	0	2000	WT/Let			0	33		
85179026	----For telegraphic switching apparatus	4.7%	0	2000	WT/Let			0	33		
85179032	----Other	8.5%	0	2000	WT/Let			0	33		
85179034	---Other	4.7%	0	2000	WT/Let			0	33		
	--Other:										
	--Printed circuit assemblies:										

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
	----For telephonic apparatus:											
85179036	----For switching or terminal apparatus (other than telephone sets)	8.5%	0	2000	WT/Let			0		33		199,
85179038	----Other	8.5%	0	2000	WT/Let			0		33		199,
85179044	----For telegraphic apparatus	4.7%	0	2000	WT/Let			0		33		199,
	---Parts, including face plates and lock latches, for printed circuit assemblies:											
	----For telephonic apparatus:											
85179048	----For switching or terminal apparatus (other than telephone sets)	8.5%	0	2000	WT/Let			0		33		
85179052	----Other	8.5%	0	2000	WT/Let			0		33		
85179056	----For telegraphic apparatus	4.7%	0	2000	WT/Let			0		33		
	---Other:											
	----For telephonic apparatus:											
85179058	----For switching or terminal apparatus (other than telephone sets)	8.5%	0	2000	WT/Let			0		33		
85179064	----Other	8.5%	0	2000	WT/Let			0		33		
85179066	----For telegraphic apparatus	4.7%	0	2000	WT/Let			0		33		
8518	Microphones and stands therefor; loudspeakers, whether or not mounted in their enclosures; headphones, earphones and combined microphone/speaker sets; audio-frequency electric amplifiers; electric sound amplifier sets; parts thereof.											
85181000	-Microphones and stands therefor											
x 85181000	--Microphones having a frequency range of 300 Hz to 3,4 KHz with a diameter of not exceeding 10 mm and a height not exceeding 3 mm, for telecommunication use	4.9%	0	2000	WT/Let			0		34		
	-Loudspeakers, whether or not mounted in their enclosures:											
85182900	--Other											
x 85182900	---Without housing, having a frequency range of 300 Hz to 3,4 KHz with a diameter of not exceeding 50 mm, for telecommunication use	4.9%	0	2000	WT/Let			0		36		
851830	-Headphones, earphones and combined microphone/speaker sets											
85183010	--Telephone handsets	8.5%	0	2000	WT/Let			0		35		
851840	-Audio-frequency electric amplifiers											

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
85184010	--For use as repeaters in line telephony	8.5%	0	2000	WT/Let			0				192,
851890	-Parts											
85189010	--Of telephone handsets and repeaters											
x 85189010	--Of repeaters of subheading 8518.40.10; printed circuit assemblies of the telephone handsets of subheading 8518.30.10	8.5%	0	2000	WT/Let			0				192,199,
85189030	--Other											
x 85189030	---Printed circuit assemblies of microphones of subheading 8518.10 having a frequency range of 300 Hz to 3,4 KHz with a diameter of not exceeding 10 mm and a height not exceeding 3 mm, for telecommunication use; printed circuit assemblies of loudspeakers of subheading 8518.29, without housing, having a frequency range of 300 Hz to 3,4 KHz with a diameter of not exceeding 50 mm, for telecommunication use	4.9%	0	2000	WT/Let			0				199,
8520	Magnetic tape recorders and other sound recording apparatus, whether or not incorporating a sound reproducing device.											
85202000	-Telephone answering machines	1.6%	0	1999	WT/Let			0	37			199,
8522	Parts and accessories suitable for use solely or principally with the apparatus of headings 8519 to 8521.											
852290	-Other											
	--Parts of telephone answering machines:											
85229045	---Printed circuit assemblies	2.8%	0	2000	WT/Let			0				199,
8523	Prepared unrecorded media for sound recording or similar recording of other phenomena, other than products of chapter 37.											
	-Magnetic tapes:											
85231100	--Of a width not exceeding 4 mm	1.7%	0	1999	WT/Let			0	38			
85231200	--Of a width exceeding 4 mm but not exceeding 6.5 mm	1.7%	0	1997	WT/Let			0	39			
85231300	--Of a width exceeding 6.5 mm	1.7%	0	1997	WT/Let			0	40			
85232000	-Magnetic discs	1.7%	0	1999	WT/Let			0	41			201,
85239000	-Other	1.7%	0	1999	WT/Let			0	42			201,

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
8524	Records, tapes and other recorded media for sound or other similarly recorded phenomena, including matrices and masters for the production of records, but excluding products of chapter 37. -Discs for laser reading systems:											
85243100	--For reproducing phenomena other than sound or image	\$0.039 per square meter of recording surface	0	1999	WT/Let			0		43		201,
85243900	--Other											
x 85243900	---For reproducing representations of instructions, data, sound, and image, recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to a user, by means of an automatic data processing machine; proprietary format recorded discs	3.7%	0	2000	WT/Let			0		44		201,
85244000	-Magnetic tapes for reproducing phenomena other than sound or image	\$0.068 per square meter of recording surface	0	2000	WT/Let			0		45		
	-Other:											
85249100	--For reproducing phenomena other than sound or image	\$0.039 per square meter of recording surface	0	1999	WT/Let			0		46		201,
852499	--Other											
85249940	---Other											
x 85249940	----For reproducing representations of instructions, data, sound, and image, recorded in a machine readable binary form, and capable of being manipulated or providing interactivity to a user, by means of an automatic data processing machine; proprietary format recorded media	\$0.039 per square meter of recording surface	0	1999	WT/Let			0		47		201,

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
8525	Transmission apparatus for radiotelephony, radiotelegraphy, radiobroadcasting or television, whether or not incorporating reception apparatus or sound recording or reproducing apparatus; television cameras; still image video cameras and other video camera recorders.											
852510	-Transmission apparatus											
85251020	--Television											
85251020	---Set top boxes which have a communication function	2.6%	0	2000	WT/Let			0				203,
	--Other:											
85251060	---Transmitters											
85251060	----Other than apparatus for radiobroadcasting	4.2%	0	2000	WT/Let			0		48		
85251080	---Other											
85251080	----Other than apparatus for radiobroadcasting	4.2%	0	2000	WT/Let			0		48		
852520	-Transmission apparatus incorporating reception apparatus											
	--Transceivers:											
	---Citizens Band (CB):											
85252005	----Hand-held	4.2%	0	2000	WT/Let			0		49		
85252015	----Other	4.2%	0	2000	WT/Let			0		49		
	---Low-power radiotelephonic transceivers operating on frequencies from 49.82 to 49.90 MHz:											
85252024	----Infant nursery intercommunication systems, each consisting in the same package of a pair of transceivers operating on frequencies from 49.82 to 49.90 MHz, and an electrical adapter	0	0	0	G/94			0		49		
85252028	----Other	1.7%	0	1999	WT/Let			0		49		
85252030	---Other	4.2%	0	2000	WT/Let			0		49		197,
85252090	--Other	2.4%	0	1997	WT/Let			0		49		
85254000	-Still image video cameras and other video camera recorders											
85254000	--Digital still image video cameras	2.9%	0	2000	WT/Let			0		50		

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
8527	Reception apparatus for radiotelephony, radiotelegraphy or radiobroadcasting, whether or not combined, in the same housing, with sound recording or reproducing apparatus or a clock.											
852790	-Other apparatus											
85279040	--Articles designed for connection to telegraphic or telephonic apparatus or instruments or to telegraphic or telephonic networks	2%	0	1997	WT/Let			0		51		
	--Other:											
85279090	---Other											
x 85279090	----Paging receivers	6%	0	2000	WT/Let			0		51		197,
8528	Reception apparatus for television, whether or not incorporating radiobroadcast receivers or sound or video recording or reproducing apparatus; video monitors and video projectors.											
	-Reception apparatus for television, whether or not incorporating radiobroadcast receivers or sound or video recording or reproducing apparatus:											
852812	--Color											
	---Other:											
	----Other:											
85281288	-----Other											
x 85281288	-----Set top boxes which have a communication function	5%	0	2000	WT/Let			0				203,
8529	Parts suitable for use solely or principally with the apparatus of headings 8525 to 8528.											
852910	-Antennas and antennas reflectors of all kinds; parts suitable for use therewith											
85291040	--Radar, radio navigational aid and radio remote control	3.4%	0	1997	WT/Let			0		52		
85291060	--Other											
x 85291060	---Antennas and antenna reflectors of a kind used with apparatus for radiotelephony and radiotelegraphy	4.2%	0	2000	WT/Let			0		52		197,
852990	-Other											
	--Printed circuit assemblies:											
85299023	---Other											

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
85299023	----Of transmission apparatus of subheading 8525.10 other than apparatus for radiobroadcasting or television; of apparatus of subheading 8525.20; of digital still image video cameras of subheading 8525.40; of paging receivers of subheading 8527.90.90 --Other, parts of printed circuit assemblies, including face plates and lock latches:	2.4%	0	1997	WT/Let			0		53		197,199,
85299076	---Other											
85299076	----Of transmission apparatus of subheading 8525.10 other than apparatus for radiobroadcasting or television; of apparatus of subheading 8525.20; of digital still image video cameras of subheading 8525.40; of paging receivers of subheading 8527.90.90 --Other parts of articles of headings 8525 and 8527, except parts of cellular telephones:	2.4%	0	1999	WT/Let			0		53		197,
85299085	---Other											
85299085	----Of transmission apparatus of subheading 8525.10 other than apparatus for radiobroadcasting or television; of apparatus of subheading 8525.20; of digital still image video cameras of subheading 8525.40; of paging receivers of subheading 8527.90.90 --Other:	2.4%	0	1997	WT/Let			0		53		197,
85299099	---Other	2.4%	0	1997	WT/Let			0		53		
8531	Electric sound or visual signalling apparatus (for example, bells, sirens, indicator panels, burglar or fire alarms), other than those of heading 8512 or 8530; parts thereof.											
85312000	-Indicator panels incorporating liquid crystal devices (LCD's) or light emitting diodes (LED's)	1.9%	0	2000	WT/Let			0		54		193,
853180	-Other apparatus											
85318040	--Paging alert devices	1.1%	0	1999	WT/Let			0				197,
85318080	--Other											
85318080	---Flat panel displays of paging alert devices of subheading 8531.80	1.9%	0	2000	WT/Let			0				193,
853190	-Parts											
85319040	--Printed circuit assemblies											

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
x 85319040	--Of the panels of subheading 8531.20; of paging alert devices or of flat panel displays for paging alert devices of subheading 8531.80	1.9%	0	2000	WT/Let			0	55			193,197,199,
85319080	--Other											
x 85319080	--Of the panels of subheading 8531.20; of paging alert devices or of flat panel displays for paging alert devices of subheading 8531.80	1.9%	0	1997	WT/Let			0	55			193,197,
8532	Electrical capacitors, fixed, variable or adjustable (pre-set); parts thereof.											
85321000	-Fixed capacitors designed for use in 50/60 Hz circuits and having a reactive power handling capacity of not less than 0.5 kvar (power capacitors)	9.4%	0	2000	WT/Let			0	56			
	-Other fixed capacitors:											
85322100	--Tantalum	9.4%	0	2000	WT/Let			0	57			
85322200	--Aluminium electrolytic	9.4%	0	2000	WT/Let			0	58			
85322300	--Ceramic dielectric, single layer	9.4%	0	2000	WT/Let			0	59			
85322400	--Ceramic dielectric, multilayer	9.4%	0	2000	WT/Let			0	60			
85322500	--Dielectric of paper or plastics	9.4%	0	2000	WT/Let			0	61			
85322900	--Other	9.4%	0	2000	WT/Let			0	62			
85323000	-Variable or adjustable (pre-set) capacitors	9.4%	0	2000	WT/Let			0	63			
85329000	-Parts	3.7%	0	2000	WT/Let			0	64			
8533	Electrical resistors (including rheostats and potentiometers), other than heating resistors; parts thereof.											
85331000	-Fixed carbon resistors, composition or film types	6%	0	2000	WT/Let			0	65			
	-Other fixed resistors:											
85332100	--For a power handling capacity not exceeding 20 W	6%	0	2000	WT/Let			0	66			
85332900	--Other	4.2%	0	2000	WT/Let			0	67			
	-Wirewound variable resistors, including rheostats and potentiometers:											
85333100	--For a power handling capacity not exceeding 20 W	6%	0	2000	WT/Let			0	68			
85333900	--Other	4.2%	0	2000	WT/Let			0	69			
853340	-Other variable resistors, including rheostats and potentiometers											
85334040	--Metal oxide varistors	0	0	0	G/94			0	70			

HS96	Description	Base rate	Bound rate	Implementation	<u>Present concession established</u> INR	<u>Concession first incorporated in a GATT Schedule</u>	Earlier INRs	ODC	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
85334080	--Other	5.3%	0	2000	WT/Let			0	70		
853390	-Parts										
85339040	--For the goods of subheading 8533.40, of ceramic or metallic materials, electrically or mechanically reactive to changes in temperature	6%	0	2000	WT/Let			0	71		
85339080	--Other	6%	0	2000	WT/Let			0	71		
85340000	Printed circuits.	3.7%	0	2000	WT/Let			0	72		
8536	Electrical apparatus for switching or protecting electrical circuits, or for making connections to or in electrical circuits (for example, switches, relays, fuses, surge suppressors, plugs, sockets, lamp-holders, junction boxes), for a voltage not exceeding 1,000 volts.										
853650	-Other switches										
85365080	--Other										
x 85365080	---Electronic AC switches consisting of optically coupled input and output circuits (insulated thyristor AC switches); electronic switches, including temperature protected electronic switches, consisting of a transistor and a logic chip (chip-on-chip technology); electromechanical snap-action switches for a current not exceeding 11 amps -Lamp-holders, plugs and sockets:	3.7%	0	2000	WT/Let			0	73,74,75		
85366900	--Other										
x 85366900	---Plugs and sockets for co-axial cables and printed circuits	3.7%	0	2000	WT/Let			0	76		
85369000	-Other apparatus										
x 85369000	--Connection and contact elements for wires and cables; wafer probers	3.7%	0	2000	WT/Let			0	77	166	
8538	Parts suitable for use solely or principally with the apparatus of heading 8535, 8536 or 8537.										
853890	-Other										
85389020	--Printed circuit assemblies										

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
xx 85389020	---Of an article of heading 8537 for one of the following: spin dryers of subheading 8421.19 for semiconductor wafer processing; deflash machines of subheading 8424.30 or 8424.89 for cleaning or removing contaminants from the metal leads of semiconductor packages prior to electroplating; spraying appliances of subheading 8424.89.30; spraying appliances of subheading 8424.89.90 for developing semiconductor wafers; spraying appliances of subheading 8424.89.90 for etching, developing, stripping or cleaning flat panel displays; automated machinery of subheading 8428.20, 8428.33, 8428.39 or 8428.90 for transport, handling and storage of semiconductor wafers, wafer cassettes, wafer boxes and other materials for semiconductor devices; lasercutters of subheading 8456.10.50 for cutting contacting tracks in semiconductor production; machines of subheading 8456.10.50 for use in production of semiconductor wafers; machines of subheading 8456.91; machines of subheading 8456.99.10; machines of subheading 8456.99.50 for stripping or cleaning semiconductor wafers; machines of subheading 8462.21 or 8462.29 for bending, folding and straightening semiconductor leads; machines of subheading 8464.10 for sawing monocrystal semiconductor boules into slices, or wafers into chips; machines of subheading 8464.20.10; machines of 8464.90 for scribing or scoring semiconductor wafers; machines of subheading 8464.90 for wet-etching, -developing or -stripping semiconductor wafers and flat panel displays; deflash machines of subheading 8465.99 for cleaning or removing contaminants from the metal leads of semiconductor packages prior to electroplating; articles of subheading 8469.11, heading 8470 or heading 8471; automatic teller machines of subheading 8472.90.20; machines of subheading 8477.10.80, 8477.40 or 8477.59 for encapsulation in the assembly of semiconductors; machines of subheading 8479.89.85 for processing of semiconductor materials; machines of	4.2%	0	2000	WT/Let			0				199,

HS96	Description	Base rate	Bound rate	Implementation	<u>Present concession</u> established INR	<u>Concession first incorporated in a</u> GATT Schedule	Earlier INRs ODC	<u>Attach. A-</u> Sect. 1	<u>Attach. A-</u> Sect. 2	<u>Attach.- B</u>
	subheading 8479.89.85 for production and assembly of diodes, transistors and similar semiconductor devices and electronic integrated circuits; machines of subheading 8479.89.95 for wet-cleaning flat panel displays; furnaces and ovens of subheading 8514.10 or 8514.20 for the manufacture of semiconductor devices on semiconductor wafers; furnaces and ovens of subheading 8514.30.40 for rapid heating of semiconductor wafers; die attach apparatus, tape automated bonders and wire bonders for assembly of semiconductors of subheading 8515.80; articles of heading 8517; articles of subheading 8520.20; set top boxes which a communication function of subheading 8525.10.20; transmission apparatus other than apparatus for radiobroadcasting of subheading 8525.10.60 or 8525.10.80; articles of subheading 8525.20; digital still image video cameras of subheading 8525.40; paging receivers of subheading 8527.90.90; ion implanters designed for doping semiconductor materials of subheading 8543.11; electrical machines with translation or dictionary functions of 8543.89; photocopying apparatus of subheading 9009.11 or 9009.21; apparatus of subheading 9010.41, 9010.42 or 9010.49; apparatus of subheading 9010.50.60 for the projection or drawing of circuit patterns on flat panel displays; plotters of subheading 9017.10 or 9017.20.90; pattern generating apparatus of subheading 9017.20.50; instruments and apparatus of heading 9026; instruments and apparatus of heading 9027 except of subheading 9027.10, 9027.40 or 9027.90.20; instruments and apparatus of subheading 9030.40; instruments and apparatus of subheading 9030.82; other optical instruments and appliances of subheading 9031.41; optical instruments and appliances of subheading 9031.49.80 for inspecting masks (other than photomasks) used in manufacturing semiconductor devices or for measuring surface particulate contamination on semiconductor wafers; electron beam microscopes fitted with equipment specifically designed for the handling and									

HS96	Description	Base rate	Bound rate	Implementation	<u>Present concession established</u> INR	<u>Concession first incorporated in a GATT Schedule</u>	Earlier INRs	ODC	<u>Attach. A-Attach. A- Sect. 1</u>	<u>Sect. 2</u>	<u>Attach.- B</u>
	transport of semiconductor wafers or reticles of subheading 9031.80										
8541	Diodes, transistors and similar semiconductor devices; photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light emitting diodes; mounted piezo-electric crystals; parts thereof.										
85411000	-Diodes, other than photosensitive or light emitting diodes	0	0	0	G/94			0	78		
	-Transistors, other than photosensitive transistors:										
85412100	--With a dissipation rate of less than 1 W	0	0	0	G/94			0	79		
85412900	--Other	0	0	0	G/94			0	80		
85413000	-Thyristors, diacs and triacs, other than photosensitive devices	0	0	0	G/94			0	81		
854140	-Photosensitive semiconductor devices, including photovoltaic cells whether or not assembled in modules or made up into panels; light emitting diodes										
85414020	--Light-emitting diodes (LED's)	0.8%	0	1999	WT/Let			0	82		
85414060	--Other diodes	0	0	0	G/94			0	82		
85414070	--Transistors	0	0	0	G/94			0	82		
	--Other:										
85414080	---Optical coupled isolators	0	0	0	G/94			0	82		
85414095	---Other	0	0	0	G/94			0	82		
85415000	-Other semiconductor devices	0	0	0	G/94			0	83		
85416000	-Mounted piezoelectric crystals	0	0	0	G/94			0	84		
85419000	-Parts	0	0	0	G/94			0	85		
8542	Electronic integrated circuits and microassemblies; parts thereof.										
	-Monolithic digital integrated circuits:										
85421200	--Cards incorporating electronic integrated circuits ("smart" cards)	0	0	0	G/94			0	86		
854213	--Metal oxide semiconductors (MOS technology)										
85421340	---For high definition television, having greater than 100,000 gates	0	0	0	G/94			0	87		
85421380	---Other	0	0	0	G/94			0	87		
854214	--Circuits obtained by bipolar technology										

HS96	Description	Base rate	Bound rate	Implementation	<u>Present concession established</u> INR	<u>Concession first incorporated in a GATT Schedule</u>	Earlier INRs	ODC	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
85421440	---For high definition television, having greater than 100,000 gates	0	0	0	G/94		0		88		
85421480	---Other	0	0	0	G/94		0		88		
854219	--Other, including circuits obtained by a combination of bipolar and MOS technologies (BIMOS technology)										
85421940	---For high definition television, having greater than 100,000 gates	0	0	0	G/94		0		89		
85421980	---Other	0	0	0	G/94		0		89		
85423000	-Other monolithic integrated circuits	0	0	0	G/94		0		90		
85424000	-Hybrid integrated circuits	0	0	0	G/94		0		91		
85425000	-Electronic microassemblies	0	0	0	G/94		0		92		
85429000	-Parts	0	0	0	G/94		0		93		
8543	Electrical machines and apparatus, having individual functions, not specified or included elsewhere in this chapter; parts thereof. -Particle accelerators:										
85431100	--Ion implanters designed for doping semiconductor materials -Other machines and apparatus:	0	0	0	G/94		0			167	
85438100	--Proximity cards and tags	3.1%	0	2000	WT/Let		0		94		
854389	--Other ---Other:										
	----Other:										
85438990	-----Other										
x 85438990	-----Electrical machines with translation or dictionary functions; flat panel displays other than for articles of heading 8528	3.1%	0	2000	WT/Let		0		95		193,
854390	-Parts --Other:										
85439055	---Printed circuit assemblies										
x 85439055	----Of ion implanters of subheading 8543.11; of flat panel displays other than for articles of heading 8528	3.1%	0	2000	WT/Let		0			170	193,199,
85439075	---Other										
x 85439075	----Of ion implanters of subheading 8543.11; of flat panel displays other than for articles of heading 8528	3.1%	0	2000	WT/Let		0			170	193,

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
8544	Insulated (including enameled or anodized) wire, cable (including coaxial cable) and other insulated electric conductors, whether or not fitted with connectors; optical fiber cables, made up of individually sheathed fibres, whether or not assembled with electric conductors or fitted with connectors. -Other electric conductors, for a voltage not exceeding 80 V:										
85444100	--Fitted with connectors										
x 85444100	---Of a kind used for telecommunications	3.7%	0	2000	WT/Let			0	96		
85444900	--Other										
x 85444900	---Of a kind used for telecommunications	4.2%	0	2000	WT/Let			0	97		
	-Other electric conductors, for a voltage exceeding 80 V but not exceeding 1,000 V:										
854451	--Fitted with connectors										
85445140	---Fitted with modular telephone connectors	3.7%	0	2000	WT/Let			0	98		
85445180	---Other										
x 85445180	----Of a kind used for telecommunications	3.7%	0	2000	WT/Let			0	98		
85447000	-Optical fiber cables	8.4%	0	2000	WT/Let			0	99		
9009	Photocopying apparatus incorporating an optical system or of the contact type and thermocopying apparatus; parts and accessories thereof. -Electrostatic photocopying apparatus:										
90091100	--Operating by reproducing the original image directly onto the copy (direct process)	2.6%	0	2000	WT/Let			0	100		
	-Other photocopying apparatus:										
90092100	--Incorporating an optical system	2.6%	0	2000	WT/Let			0	101		
900990	-Parts and accessories										
	--Parts of photocopying apparatus of subheading 9009.12 specified in additional U.S. note 5 to this chapter:										
90099010	---Parts other than photoreceptors or assemblies containing photoreceptors	0	0	0	G/94			0	102		199,
90099030	---Other	2.6%	0	1997	WT/Let			0	102		
	--Other:										

HS96	Description	Base rate	Bound rate	Implementation	<u>Present concession established</u> INR	<u>Concession first incorporated in a GATT Schedule</u>	Earlier INRs ODC	<u>Attach. A-Attach. A- Sect. 1</u>	<u>Sect. 2</u>	<u>Attach.- B</u>
90099050	---Parts and accessories, other than photoreceptors or assemblies containing photoreceptors, of electrostatic copying machines of subheading 9009.12	0	0	0	G/94		0	102		199,
90099070	---Other	2.6%	0	1997	WT/Let		0	102		
9010	Apparatus and equipment for photographic (including cinematographic) laboratories (including apparatus for the projection or drawing of circuit patterns on sensitized semiconductor materials), not specified or included elsewhere in this chapter; negatoscopes; projection screens; parts and accessories thereof. -Apparatus for the projection or drawing of circuit patterns on sensitized semiconductor materials:									
90104100	--Direct write-on-wafer apparatus	0	0	0	G/94		0		171	
90104200	--Step and repeat aligners	0	0	0	G/94		0		172	
90104900	--Other	0	0	0	G/94		0		173	
901050	-Other apparatus and equipment for photographic (including cinematographic) laboratories; negatoscopes									
90105060	--Other	0	0	0	G/94		0		173	
901090	-Parts and accessories									
90109080	--Other									
90109080	--Of the apparatus of subheadings 9010.41 to 9010.49; of apparatus of subheading 9010.50.60 for the projection or drawing of circuit patterns on flat panel displays	4%	0	2000	WT/Let		0		174	
9013	Liquid crystal devices not constituting articles provided for more specifically in other headings; lasers, other than laser diodes; other optical appliances and instruments, not specified or included elsewhere in this chapter; parts and accessories thereof.									
901380	-Other devices, appliances and instruments									
90138060	--Other									
90138060	---Flat panel displays other than for articles of heading 8528	6.3%	0	2000	WT/Let		0			193,
901390	-Parts and accessories									
90139040	--Other									

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>INR</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
× 90139040	---Of flat panel displays other than for articles of heading 8528	6.3%	0	2000	WT/Let			0				193,199,
9017	Drawing, marking-out or mathematical calculating instruments (for example, drafting machines, pantographs, protractors, drawing sets, slide rules, disc calculators); instruments for measuring length, for use in the hand (for example, measuring rods and tapes, micrometers, calipers), not specified or included elsewhere in this chapter; parts and accessories thereof											
90171000	-Drafting tables and machines, whether or not automatic											
× 90171000	--Plotters	4.3%	0	2000	WT/Let			0				198,
901720	-Other drawing, marking-out or mathematical calculating instruments											
90172050	--Pattern generating apparatus designed to produce masks and reticles from photoresist coated substrates (such as optical, E-beam, focused ion beam, X-ray or laser beam apparatus except those of subheading 8456.99.10)	0	0	0	G/94			0		181		
90172090	--Other											
× 90172090	---Plotters	5.1%	0	2000	WT/Let			0				198,
90179000	-Parts and accessories											
× 90179000	--Of the apparatus of subheading 9017.20.50	0	0	0	G/94			0		182,183	199,	
× 90179000	--Printed circuit assemblies of plotters of subheading 9017.10	4.3%	0	2000	WT/Let			0				199,
× 90179000	--Printed circuit assemblies of plotters of subheading 9017.20.90	5.1%	0	2000	WT/Let			0				199,
9026	Instruments and apparatus for measuring or checking the flow, level, pressure or other variables of liquids or gases (for example, flow meters, level gauges, manometers, heat meters), excluding instruments and apparatus of heading 9014, 9015, 9028 or 9032; parts and accessories thereof.											
902610	-For measuring or checking the flow or level of liquids											
90261020	--Electrical	3%	0	1997	WT/Let			0	103			
	--Other:											

HS96	Description	Base rate	Bound rate	Implementation	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	Earlier INRs	ODC	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
90261040	---Flow meters	\$0.30 each + 4.7%	0	2000	WT/Let			0	103		
90261060	---Other	2.8%	0	1997	WT/Let			0	103		
902620	-For measuring or checking pressure										
90262040	--Electrical	3%	0	1997	WT/Let			0	104		
90262080	--Other	2.8%	0	1997	WT/Let			0	104		
902680	-Other instruments or apparatus										
90268020	--Electrical	3%	0	1997	WT/Let			0	105		
	--Other:										
90268040	---Heat meters incorporating liquid supply meters, and anemometers	\$0.296 each + 4.6%	0	2000	WT/Let			0	105		
90268060	---Other	2.8%	0	1997	WT/Let			0	105		
902690	-Parts and accessories										
90269020	--Of electrical instruments and apparatus	3%	0	2000	WT/Let			0	106		199,
	--Other:										
90269040	---Of flow meters, heat meters incorporating liquid supply meters and anemometers	5.5%	0	2000	WT/Let			0	106		
90269060	---Other	2.8%	0	1997	WT/Let			0	106		
9027	Instruments and apparatus for physical or chemical analysis (for example, polarimeters, refractometers, spectrometers, gas or smoke analysis apparatus); instruments and apparatus for measuring or checking viscosity, porosity, expansion, surface tension or the like; instruments and apparatus for measuring or checking quantities of heat, sound or light (including exposure meters); microtomes; parts and accessories thereof.										
902720	-Chromatographs and electrophoresis instruments										
	--Electrical:										
90272042	---Electrophoresis instruments, not incorporating an optical or other measuring device	2.6%	0	1997	WT/Let			0	107		
90272044	---Other	3%	0	1997	WT/Let			0	107		
90272080	--Other	3.8%	0	2000	WT/Let			0	107		

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
902730	-Spectrometers, spectrophotometers and spectrographs using optical radiations (UV, visible, IR)										
90273040	--Electrical	3%	0	1997	WT/Let			0	108		
90273080	--Other	6.1%	0	2000	WT/Let			0	108		
902750	-Other instruments and apparatus using optical radiations (UV, visible, IR)										
90275040	--Electrical	3%	0	1997	WT/Let			0	109		
90275080	--Other	6.1%	0	2000	WT/Let			0	109		
902780	-Other instruments and apparatus										
90278025	--Nuclear magnetic resonance instruments	3%	0	1997	WT/Let			0	110		
	--Other:										
90278045	---Electrical	3%	0	1997	WT/Let			0	110		
90278080	---Other	3.8%	0	2000	WT/Let			0	110		
902790	-Microtomes; parts and accessories										
	--Parts and accessories:										
	---Of electrical instruments and apparatus:										
90279042	----Of electrophoresis instruments not incorporating an optical or other measuring device	2.6%	0	1997	WT/Let			0	111		
	----Other:										
90279045	-----Printed circuit assemblies for the goods of subheading 9027.80	3%	0	1997	WT/Let			0	111		199,
90279055	-----Other										
90279055	-----Of instruments and apparatus of heading 9027.20, 9027.30, 9027.40, 9027.50 or 9027.80	3%	0	1997	WT/Let			0	111		
	---Other:										
90279060	----Of optical instruments and apparatus										
90279060	-----Of instruments and apparatus of heading 9027.20, 9027.30, 9027.40, 9027.50 or 9027.80	6.1%	0	2000	WT/Let			0	111		199,
90279080	----Other										
90279080	-----Of instruments and apparatus of heading 9027.20, 9027.30, 9027.40, 9027.50 or 9027.80	3.8%	0	2000	WT/Let			0	111		

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
9030	Oscilloscopes, spectrum analyzers and other instruments and apparatus for measuring or checking electrical quantities, excluding meters of heading 9028; instruments and apparatus for measuring or detecting alpha, beta, gamma, X-ray, cosmic or other ionizing radiations; parts thereof.										
90304000	-Other instruments and apparatus, specially designed for telecommunications (for example, cross-talk meters, gain measuring instruments, distortion factor meters, psophometers) -Other instruments and apparatus:	3%	0	1997	WT/Let		0	112			
90308200	--For measuring or checking semiconductor wafers or devices	0	0	0	G/94		0			184	
903090	-Parts and accessories --Other:										
90309065	---Printed circuit assemblies										
x 90309065	----Of instruments and apparatus of subheading 9030.82	3%	0	2000	WT/Let		0			185,186	199,
90309085	---Other										
x 90309085	----Of instruments and apparatus of subheading 9030.82	3%	0	2000	WT/Let		0			185,186	
9031	Measuring or checking instruments, appliances and machines, not specified or included elsewhere in this chapter; profile projectors; parts and accessories thereof. -Other optical instruments and appliances:										
90314100	--For inspecting semiconductor wafers or devices or for inspecting photomasks or reticles used in manufacturing semiconductor devices	0	0	0	G/94		0			175,176, 187,188	
903149	--Other										
90314980	---Other										
90314980	----For inspecting masks (other than photomasks) used in manufacturing semiconductor devices; for measuring surface particulate contamination on semiconductor wafers	6.1%	0	2000	WT/Let		0			187,188	
90318000	-Other instruments, appliances and machines										

<u>HS96</u>	<u>Description</u>	<u>Base rate</u>	<u>Bound rate</u>	<u>Implementation</u>	<u>Present concession established</u>	<u>Concession first incorporated in a GATT Schedule</u>	<u>Earlier INRs</u>	<u>ODC</u>	<u>Attach. A- Sect. 1</u>	<u>Attach. A- Sect. 2</u>	<u>Attach.- B</u>
»x 90318000	---Electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles	3%	0	2000	WT/Let			0		179	
903190	-Parts and accessories										
	--Of other optical instruments and appliances, other than test benches:										
90319055	---Other										
»x 90319055	----Of optical instruments and appliances for inspecting semiconductor wafers or devices or for inspecting masks, photomasks or reticles used in manufacturing semiconductor devices; of optical instruments and appliances for measuring surface particulate contamination on semiconductor wafers	6.1%	0	2000	WT/Let			0		177,178, 189,190	199,
90319060	--Other										
»x 90319060	---Of electron beam microscopes fitted with equipment specifically designed for the handling and transport of semiconductor wafers or reticles of subheading 9031.80	3%	0	2000	WT/Let			0		180	